NOTICE (	OF REVISION (NOR) AS BEEN AUTHORIZED FOR THE	E DOCUMENT LISTED	1. DATE (YYMMDD) 00/08/04	Form Approved OMB No. 0704-0188
Public reporting burden for this collection of information existing data sources, gathering and maintaining the da burden estimate or any other aspect of this collection of	l comments regarding this t of Defense, Washington	2. PROCURING ACTIVITY NO.		
Headquarters Services, Directorate for Information Ope Office of Management and Dudget. Paperwork Reduction TO EITHER OF THESE ADDRESSES. RETURN CONTRACT/PROCURING ACTIVITY NUMBER LISTED	n Project (0704-0188) Washington DC 20503. COMPLETED FORM TO THE GOVERNI	PLEASE DO NOT RETURN YO	OUR COMPLETED FORM	3. DODAAC
4. ORIGINATOR	b. ADDRESS (Street, City, State	Zip Code)	5. CAGE CODE	6. NOR NO.
a. TYPED NAME (First, Middle Initial, Last)	Post Office Box 3990		037Z3	5999-R004-00
Defense Supply Center, Columbus	Columbus, OH 43216-5000		7. CAGE CODE 14933	8. DOCUMENT NO. 85008
9. TITLE OF DOCUMENT		10. REVISION LETTER	14000	11. ECP NO.
DELAY LINES, ACTIVE, 5 TAPS, 14-PI	N DIP,	a. CURRENT	b. NEW	]
TTL INTERFACED		E	F	NONE
12. CONFIGURATION ITEM (OR SYSTEM	I) TO WHICH ECP APPLIES	<b>_</b>		1
13. DESCRIPTION OF REVISION				
Page 1: Revisions letter column; add "F" Revisions description column; a Revisions date column; add "00	dd "Changes in accordance with I	NOR 5999-R004-00."		
Page 8: Table, delete CAGE "16714" and	d all associated part numbers.			
Page 9: Delete CAGE "16714, Rhombus source of supply.	Industries, Incorporated, 15801 (	Chemical Lane, Huntingt	on Beach, CA 9264	9, (714) 898-0960" as a
14. THIS SECTION FOR GOVERNMENT	USE ONLY			
a. (X one) X (1) Existing document	supplemented by this NOR may be		<del></del>	
	must be received before manufact			
b. ACTIVITY AUTHORIZED TO APPROV	r document shall make above revi	c. TYPED NAME (F		ust)
DSCC-V		·	KENDALL A. COTT	·
d. TITLE	e. SIGNATURE	1	f. 1	DATE SIGNED (YYMMDD)
CHIEF, ELECTRONIC COMPONENTS TE		At 3		00/08/04
15a. ACTIVITY ACCOMPLISHING REVIS	ION b. BEVISION COMPLETE	D (Signature)	c.	DATE SIGNED (YYMMDD)
DSCC - VAT	1 KJ C	$(\dot{a})$		00/08/04
DD FORM 1695, APR 92	PREVIOUS	EDITIONS ARE OBSOLE	L	

	REVISIONS								
LTR	DESCRIPTION	DATE	E APPROVED						
Α	Added three sources for all dash numbers.	05 Sep 85	Ivan R. Jones						
В	Modified figure 1 and added footnotes. Added tables II and III. Deleted references to MIL-D-23859; substituted references to MIL-D-83532. Updated vendor table.	01 Jul 87	Randy Larson						
С	Changed standoff requirements in note 4 of figure 1.	19 Oct 87	Randy Larson						
D	Corrected I <sub>CCL</sub> max limit on table III. Added note 6 to figure 1. Changed pin length and added tolerances to pin dimensions. Added three vendors. Editorial changes throughout.	17 Aug 88	Randy Larson						
E	Changed 3.3. Moved output rise time data from table III to 3.6. Changed several dimensions on figure 1 and added notes 7 and 8. Deleted vendors 92912 and 56289.	21 Dec 92	Tony						

THE ORIGINAL FIRST PAGE OF THIS DRAWING HAS BEEN REPLACED.

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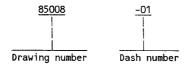
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#### SCOPE

- 1.1 <u>Scope</u>. This drawing describes the requirements for a family of active 14-pin, 5 tap, TTL interfaced delay lines.
  - 1.2 Part or Identifying Number (PIN). The complete PIN shall be as shown in the following example:



## 2. APPLICABLE DOCUMENTS

### 2.1 Government documents.

2.1.1 <u>Government specifications and standards</u>. The following specifications and standards form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents shall be those listed in the issue of the Department of Defense Index of Specifications and Standards and supplement thereto, cited in the solicitation.

#### **SPECIFICATIONS**

### MILITARY

MIL-S-19491 - Semiconductor Devices, Packaging of.

MIL-M-38510 - Microcircuits, General Specification for.

MIL-D-83532 - Delay Lines, Active, General Specification for.

#### STANDARDS

## MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

MIL-STD-1295 - Marking of Electrical and Electronic Parts.

(Copies of the specifications and standards required by contractors in connection with specific acquisition functions may be obtained from the DODSSP, Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence. Nothing in this drawing, however, shall supersede applicable laws and regulations unless a specific exemption has been obtained.

## 3. REQUIREMENTS

- 3.1 <u>Case material</u>. The case material shall be molded diallyl phthalate or encapsulated epoxy and be in accordance with MIL-D-83532.
  - 3.2 <u>Terminal material</u>. The terminal material shall be in accordance with MIL-M-38510.
  - 3.3 Integrated circuits (IC's). IC's shall meet the requirements of MIL-STD-883, level B, as a minimum.
  - 3.4 <u>Design and dimensions</u>. The design and dimensions shall be in accordance with figure 1 and table I.
- 3.5 <u>Delay times</u>. The delay times from input to all taps shall be as specified in table I (+25°C) and table II (-55°C and +125°C).

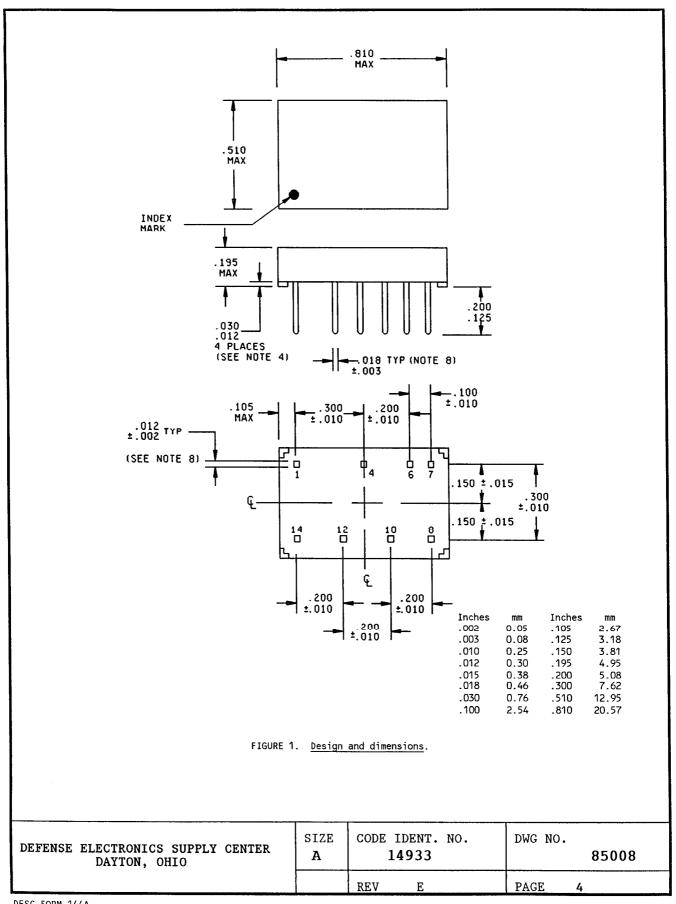
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 14933	DWG NO. 85008
		REV E	PAGE 2

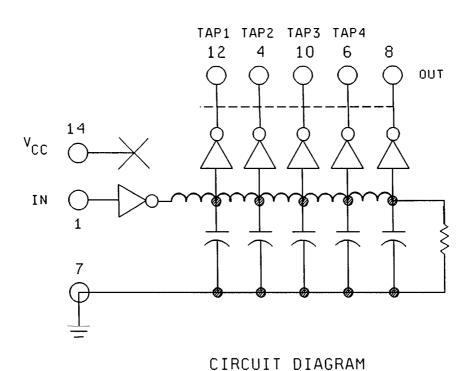
3.6 Output rise time. 4 ns maximum under the following conditions:

 $V_{CC} = 5.0 \text{ V}$ ;  $TR_T \le 3 \text{ ns}$ ;  $C_1 = 50 \text{ pF}$ ;  $R_1 = 500 \text{ ohms}$ . Applied to leading edge only.

- 3.7 <u>DC characteristics</u>. DC characteristics shall be as specified in table III.
- 3.8 Delay line fan-out. The delay line fan-out shall be 20 maximum (20 TTL loads per delay line).
- 3.9 Tap fan-out. The tap fan-out shall be 10/tap maximum (one tap is capable of driving 10 TTL load maximum).
- 3.10 Marking. Each delay line shall be marked on the top in accordance with method I of MIL-STD-1285 with the following information:
  - a. Complete PIN (see 1.2).
  - b. Index mark identification (over pin 1, input).
  - c. Manufacturer's Commercial and Government Entity (CAGE) code or logo.
  - d. Date code.
- 5.11 Workmanship. Parts shall be processed in such a manner as to be representative of controlled industrial techniques. Surfaces shall be free from burrs, die marks, chatter marks, scratches, dirt, grease, scale, splinters, and other defects that will affect life, serviceability, performance, or appearance. Visible parting line is acceptable.
- 3.12 <u>Certificate of compliance</u>. A certificate of compliance is required from each manufacturer requesting to be listed as a suggested source of supply (see 6.3). The certificate shall state that the manufacturer's product meets all the requirements of this drawing.
  - 4. QUALITY ASSURANCE PROVISIONS
  - 4.1 Quality conformance inspection.
- 4.1.1 <u>Inspection of product for delivery</u>. Inspection of product for delivery shall consist of compliance with group A inspection for level A of MIL-D-83532.
- 4.1.2 <u>Inspection of packaging</u>. The sampling and inspection of the preservation, packing, and container marking shall be in accordance with the requirements for semiconductor devices in MIL-S-19491.
  - PACKAGING
  - 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-S-19491.
  - 6. NOTES
- 6.1 <u>Intended use.</u> Devices conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application.
  - 6.2 Ordering data. The acquisition document should specify the following as a minimum:
    - a. Complete PIN (see 1.2).
    - b. Requirement for the manufacturer to include one copy of the quality conformance inspection data with each chipment of parts.
    - c. Requirement for the manufacturer to notify the acquiring activity in the event of a change in product.

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## NOTES:

- 1. Dimensions are in inches.
- 2. Metric equivalents are given for general information only.
- 3. Unless otherwise specified, tolerance is ±.005 (0.13 mm).
- 4. Location and shape of standoffs are optional.
- 5. Pins 2, 3, 5, 9, 11, and 13 may be omitted at the manufacturer's option.6. Tolerances on dimensions separating leads are nonaccumulative.
- 7. Leads shall be free of case meniscus and other foreign material and shall be solderable for a minimum of .010 inch above the seating plane of the delay line.
- 8. Leads may be round at the discretion of the manufacturer. Round lead diameter shall be  $.020 \pm .002$ .

FIGURE 1. Design and dimensions - Continued.

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TABLE I. Delay times at  $+25^{\circ}$ C,  $V_{CC} = 5.00 \pm .01 \text{ volts}$ .

PIN		Delay	times in nanose	econds	
85008-	Pin 12	Pin 4	Pin 10	Pin 6	Pin 8
	tap 1	tap 2	tap 3	tap 4	output
01	5 ±2 ns	10 ±2 ns	15 ±2 ns	20 ±2 ns	25 ±2 ns
02	6 ±2 ns	12 ±2 ns	18 ±2 ns	24 ±2 ns	30 ±2 ns
03	7 ±2 ns	14 ±2 ns	21 ±2 ns	28 ±2 ns	35 ±2 ns
04	8 ±2 ns	16 ±2 ns	24 ±2 ns	32 ±2 ns	40 ±2 ns
05	9 ±2 ns	18 ±2 ns	27 ±2 ns	36 ±2 ns	45 ±5%
06	10 ±2 ns	20 ±2 ns	30 ±2 ns	40 ±2 ns	50 ±5%
07	15 ±2 ns	30 ±2 ns	45 ±5%	60 ±5%	75 ±5%
08	20 ±2 ns	40 ±2 ns	60 ±5%	80 ±5%	100 ±5%
09	25 ±2 ns	50 ±5%	75 ±5%	100 ±5%	125 ±5%
10	30 ±2 ns	60 ±5%	90 ±5%	120 ±5%	150 ±5%
11	35 ±2 ns	70 ±5%	105 ±5%	140 ±5%	175 ±5%
12	40 ±2 ns	80 ±5%	120 ±5%	160 ±5%	200 ±5%
13	45 ±5%	90 ±5%	135 ±5%	180 ±5%	225 ±5%
14	50 ±5%	100 ±5%	150 ±5%	200 ±5%	250 ±5%
15	60 ±5%	120 ±5%	180 ±5%	240 ±5%	300 ±5%
1	70 15%	4/0 .5%	240 .5%	200 .5%	750 15%
16	70 ±5%	140 ±5%	210 ±5%	280 ±5%	350 ±5%
17	80 ±5%	160 ±5%	240 ±5%	320 ±5%	400 ±5%
18	90 ±5%	180 ±5%	270 ±5%	360 ±5%	450 ±5%
19	100 ±5%	200 ±5%	300 ±5%	400 ±5%	500 ±5%

TABLE II. Delay times at -55°C and +125°C,  $V_{CC} = 5.00 \pm .01 \text{ volts.}$ 

PIN		Delay '	times in nanoseco	onds	
85008-	Pin 12	Pin 4	Pin 10	Pin 6	Pin 8
	tap 1	tap 2	tap 3	tap 4	output
01	5 ±3 ns	10 ±3 ns	15 ±3 ns	20 ±3 ns	25 ±3 ns
02	6 ±3 ns	12 ±3 ns	18 ±3 ns	24 ±3 ns	30 ±3 ns
03	7 ±3 ns	14 ±3 ns	21 ±3 ns	28 ±3 ns	35 ±3 ns
04	8 ±3 ns	16 ±3 ns	24 ±3 ns	32 ±3 ns	40 ±3 ns
05	9 ±3 ns	18 ±3 ns	27 ±3 ns	36 ±3 ns	45 ±8%
06 07 08 09 10	10 ±5 ns 15 ±3 ns 20 ±3 ns 25 ±3 ns 30 ±3 ns	20 ±3 ns 30 ±3 ns 40 ±3 ns 50 ±8%	30 ±3 ns 45 ±8% 60 ±8% 75 ±8% 90 ±6%	40 ±3 ns 60 ±8% 80 ±8% 100 ±8% 120 ±8%	50 ±8% 75 ±8% 100 ±8% 125 ±8% 150 ±8%
11	35 ±3 ns	70 ±8%	105 ±8%	140 ±8%	175 ±8%
12	40 ±3 ns	80 ±8%	120 ±8%	160 ±8%	200 ±8%
13	45 ±8%	90 ±8%	135 ±8%	180 ±8%	225 ±8%
14	50 ±8%	100 ±8%	150 ±8%	200 ±8%	250 ±8%
15	60 ±8%	120 ±8%	180 ±8%	240 ±8%	300 ±8%
16	70 ±8%	140 ±8%	210 ±8%	280 ±8%	350 ±8%
17	80 ±8%	160 ±8%	240 ±8%	320 ±8%	400 ±8%
18	90 ±10%	180 ±8%	270 ±8%	360 ±8%	450 ±8%
19	100 ±10%	200 ±8%	300 ±8%	400 ±8%	500 ±8%

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# TABLE III. <u>DC characteristics</u>.

Test	Symbol	Conditions	Lim	its	Unit
		-55°C ≤ T <sub>C</sub> ≤ +125°C	Min	Max	
High level output voltage	v <sub>он</sub>	$v_{CC} = 4.5 \text{ V} $ $V_{IH} = 2.0 \text{ V} $ $I_{OH} = -1 \text{ mA} $	2.5		V
low level output voltage	V <sub>OL</sub>	v <sub>cc</sub> = 4.5 v VIL = 0.8 V I <sub>OL</sub> = 20 mA		.5	V
Input clamp voltage	v <sub>IC</sub>	$V_{CC} = 4.5 \text{ V}$ I I = -18 mA $T_{C} = +25^{\circ}\text{C}$		-1.2	V
High level input current	I <sub>IH</sub> 1	v <sub>CC</sub> - 5.5 v, v <sub>IH</sub> - 2.7 v		50	μΑ
	I <sub>IH2</sub>	v <sub>cc</sub> = 5.5 v, v <sub>IH</sub> = 5.5 v		1000	μΑ
Low level input current	IIL	v <sub>cc</sub> = 5.5 v, v <sub>IL</sub> = .5 v		-2.00	mA
Short circuit output current	Ios	V <sub>CC</sub> = 5.5 V, V <sub>OS</sub> = 0.0 V Not more than one output shorted at a time	-40	-150	mA
Low level supply current	ICCL	v <sub>cc</sub> = 5.5 v v <sub>I</sub> = 0.0 v		75	mA

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6.3 <u>Suggested sources of supply</u>. Suggested sources of supply are listed below. Additional sources will be added as they become available. This table is not a qualified products list or an approved source list. The vendors indicated have submitted certificates of compliance to DESC; however, parts may be ordered from any manufacturer who agrees to supply components which conform to all the requirements of this drawing.

		Sim	ilar vendor PIN	and CAGE	code <u>1</u> /	
DESC PIN 85008-	00222	50965	22519	20933	16714	62694
01	9T25\$	4508-01	DDU6-8512-1	00т204	DSP008-01	L-13-904
02	9T30s	4508-02	DDU6-8512-2	00т205	DSP008-02	L-13-905
03	9T <b>3</b> 5S	4508-03	DDU6-8512-3	00T206	DSP008-03	L-13-906
04	9T40s	4508-04	DDU6-8512-4	00т207	DSP008-04	L-13-907
05	9T45S	4508-05	DDU6-8512-5	00т208	DSP008-05	L-13-908
06	9T50s	4508-06	DDU6-8512-6	00T209	DSP008-06	L-13-909
07	9T75S	4508-07	DDU6-8512-7	00т210	DSP008-07	L-13-910
08	9T100s	4508-08	DDU6-8512-8	10т363	DSP008-08	L-13-911
09	9T125S	4508-09	DDU6-8512-9	10т364	DSP008-09	L-13-912
10	9T150s	4508-10	DDU6-8512-10	10T365	DSP008-10	L-13-913
11	9T175S	4508-11	DDU6-8512-11	10т366	DSP008-11	L-13-914
12	9T200s	4508-12	DDU6-8512-12	10т367	DSP008-12	L-13-915
13	9T225S	4508-13	DDU6-8512-13	10T368	DSP008-13	L-13-916
14	9T250S	4508-14	DDU6-8512-14	10т369	DSP008-14	L-13-917
15	9T300s	4508-15	DDU6-8512-15	10T370	DSP008-15	L-13-918
16	9T350s	4508-16	DDU6-8512-16	10т371	DSP008-16	L-13-919
17	9T400S	4508-17	DDU6-8512-17	10Т372	DSP008-17	L-13-920
18	9T450S	4508-18	DDU6-8512-18	10Т373	DSP008-18	L-13-921
19	9T500s	4508-19	DDU6-8512-19	10т374	DSP008-19	L-13-922

 $<sup>\</sup>underline{1}/$  CAUTION: Vendor PIN's are provided for reference purposes only. Do not use these numbers for item acquisition and marking.

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Vendor CAGE number	Vendor name <u>and address</u>		
00222	ESC Electronics Corporation 534 Bergen Boulevard Palisades Park, NJ 07650 (201) 947-0400		
16714	Rhombus Industries, Incorporated 15801 Chemical Lane Huntington Beach, CA 92649 (714) 898-0960		
20933	Kappa Technologies, Incorporated 1443 Pinewood Street Rahway, NJ 07065 (908) 396-9400		
22519	Data Delay Devices, Incorporated 3 Mt. Prospect Avenue Clifton, NJ 07013 (201) 773-2299		
50965	Princeton Advanced Components, Incorporated 860 State Road Princeton, NJ 08540 (609) 924-2444		
62694	JBM Electronics 1 Commerce Drive Bedford, NH 03110 (603) 623-0222		

6.4 <u>Assistance</u>. Questions or comments concerning this drawing should be referred to DESC-EMM, 1507 Wilmington Pike, Dayton, OH 45444-5270, telephone (513) 296-5255.

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